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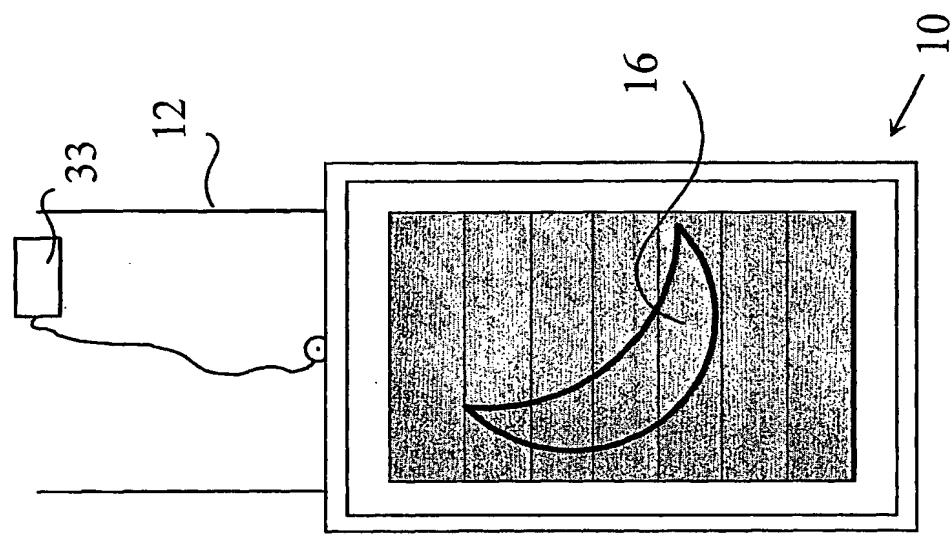


Fig. 1B

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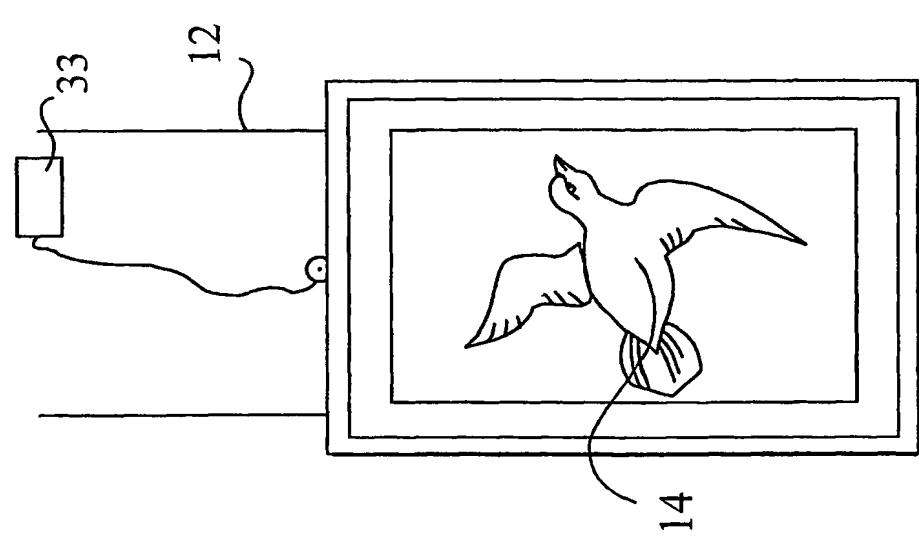


Fig. 1A

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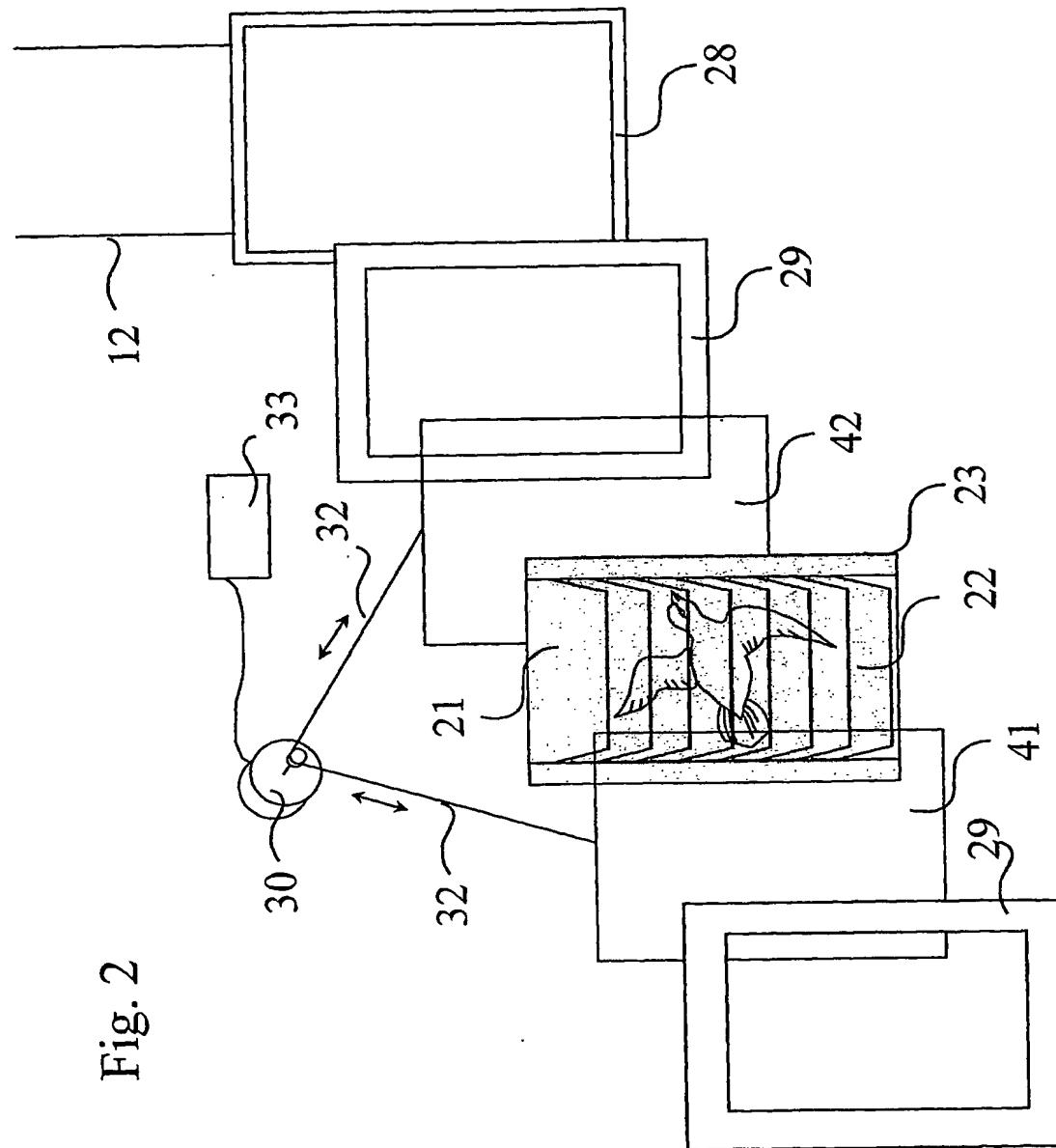
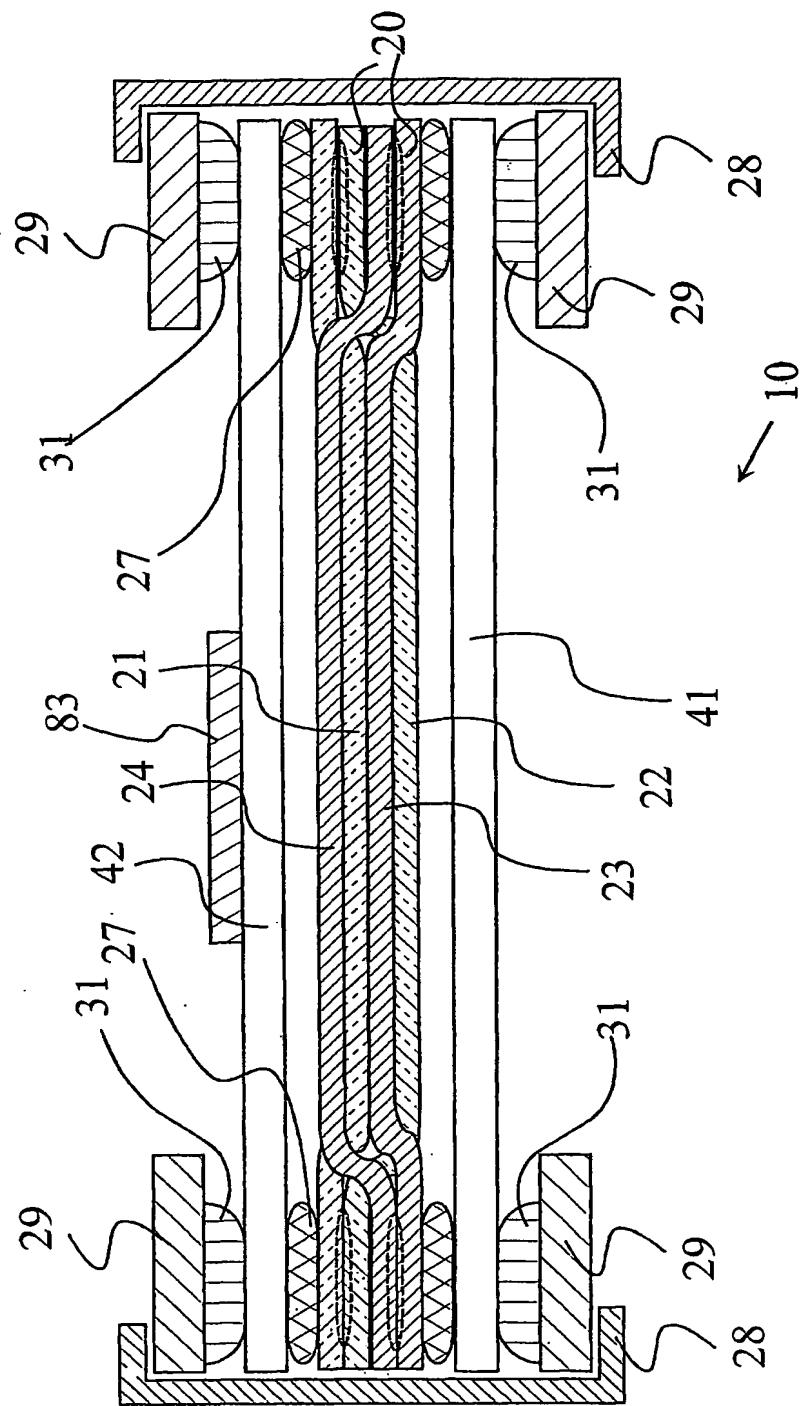


Fig. 2

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Fig. 3



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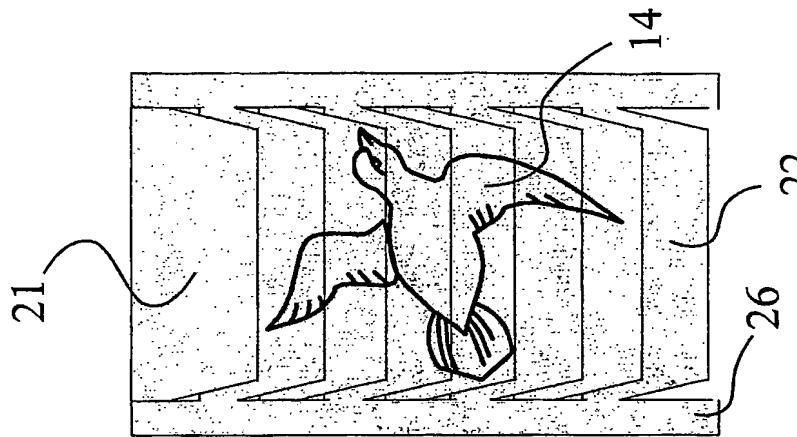


Fig. 6

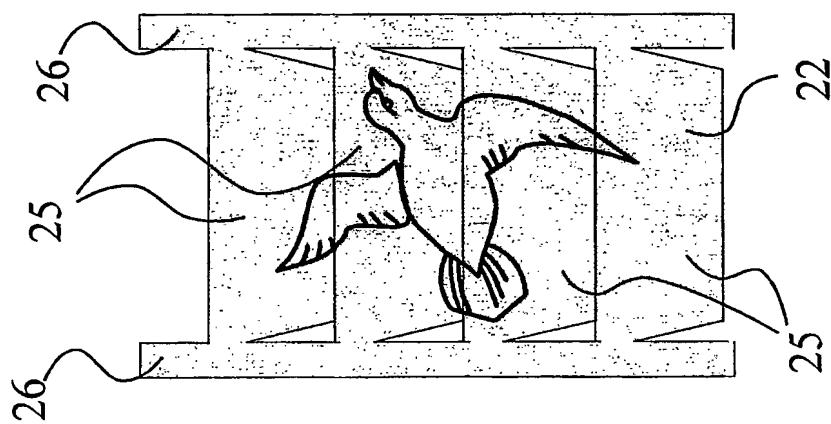


Fig. 5

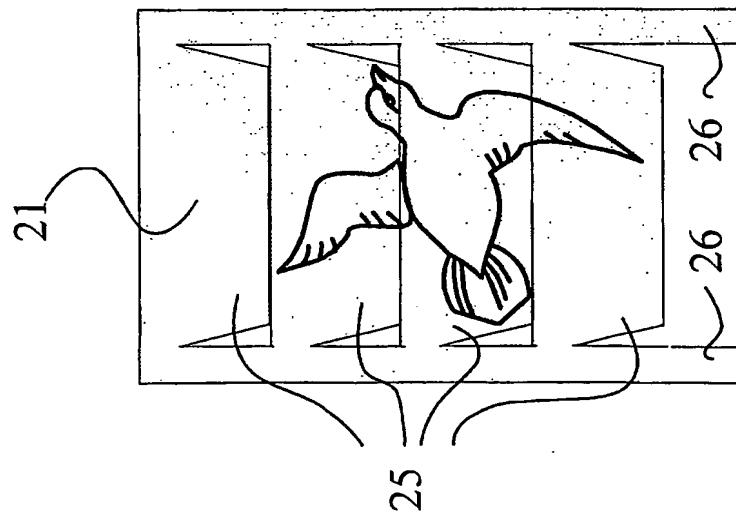


Fig. 4

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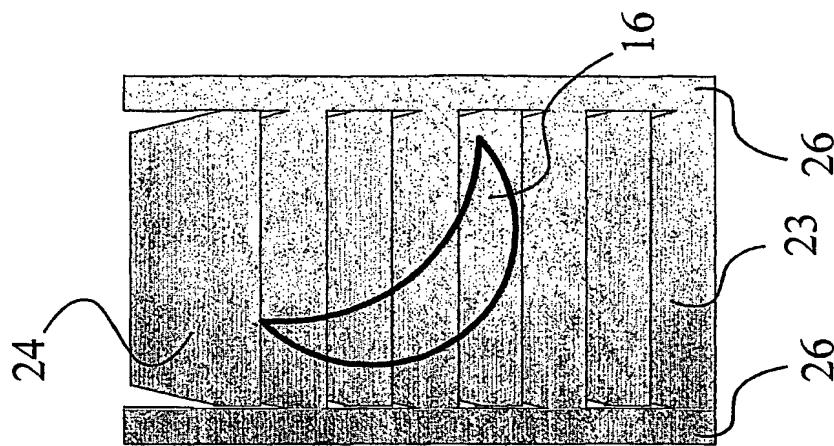


Fig. 9

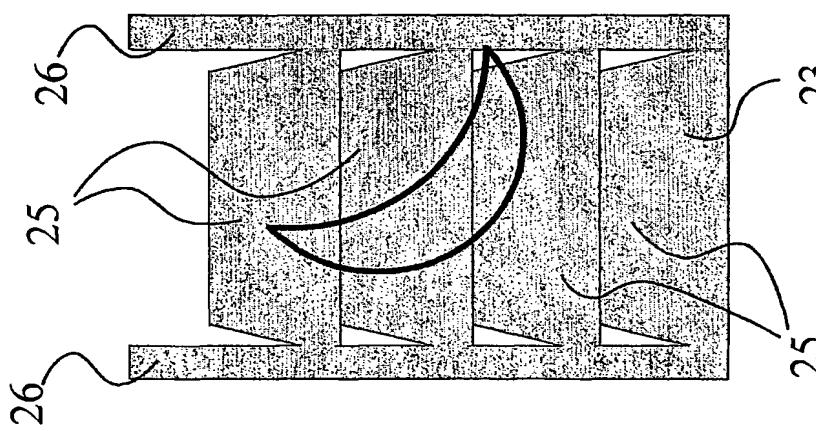


Fig. 8

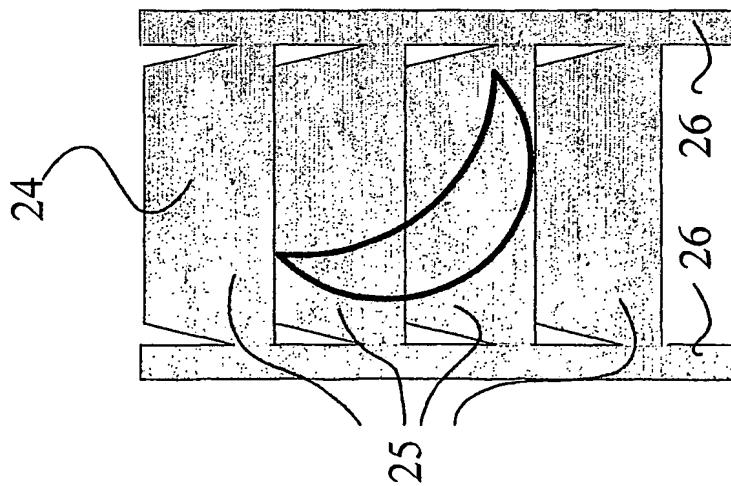


Fig. 7

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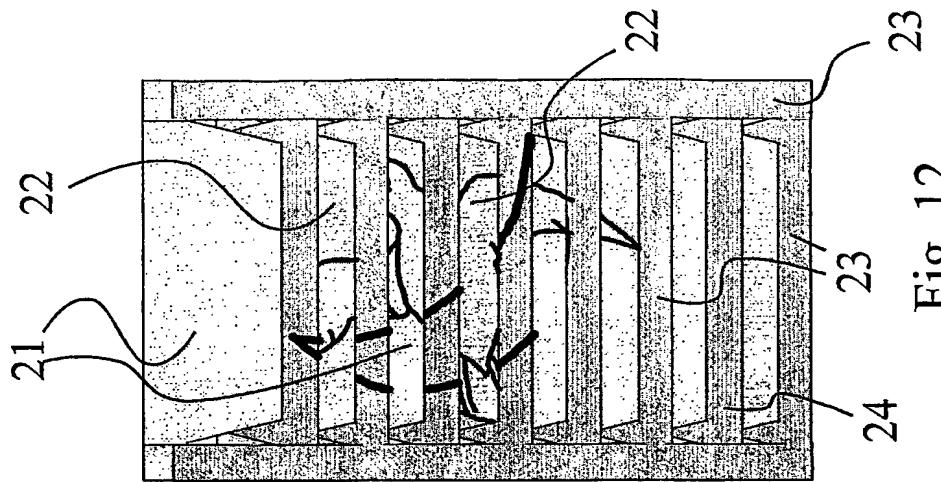


Fig. 12

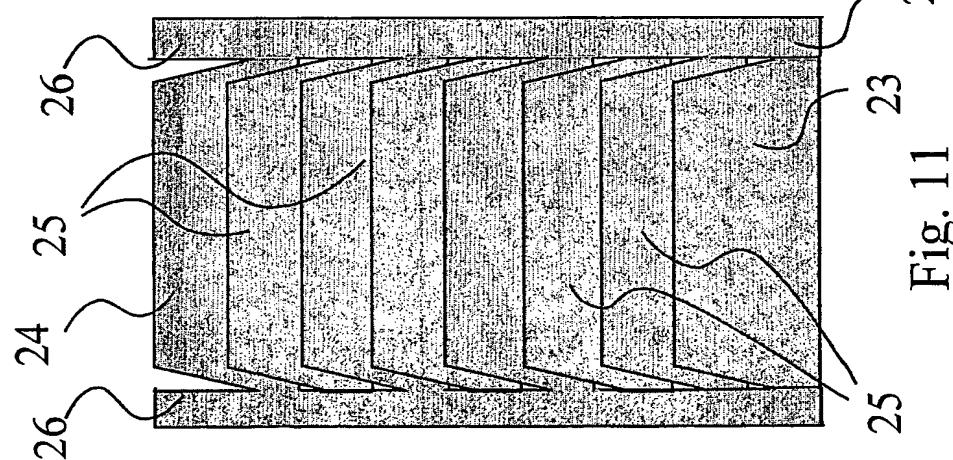


Fig. 11

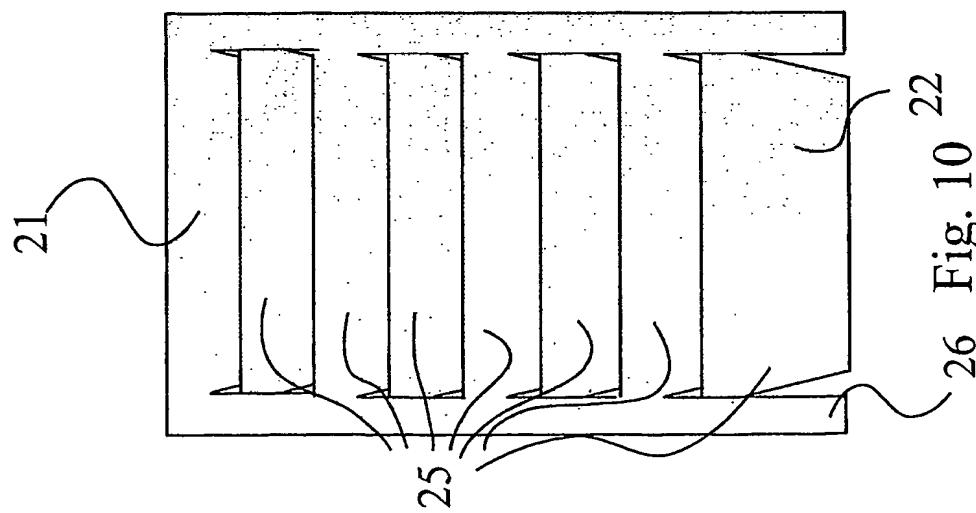


Fig. 10

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Fig. 13A

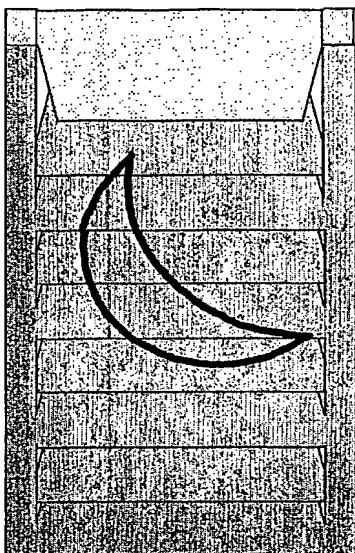


Fig. 13B

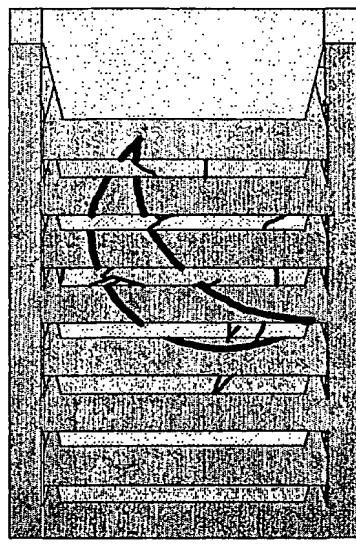


Fig. 13C

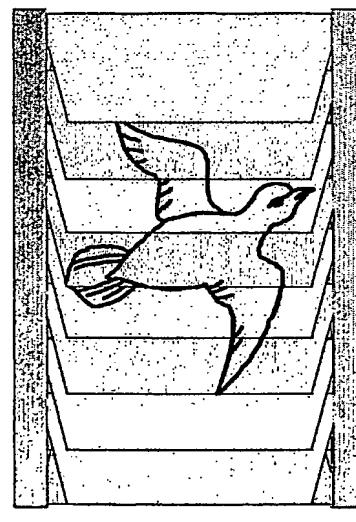
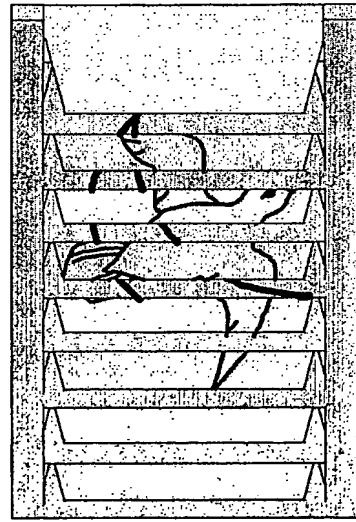
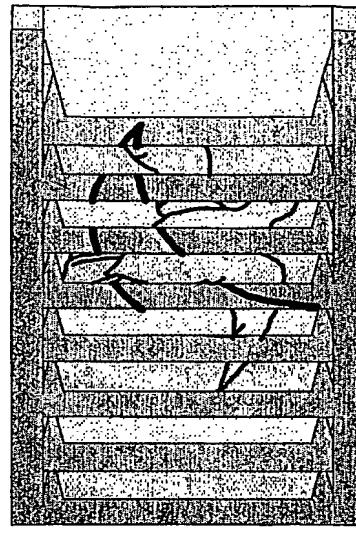


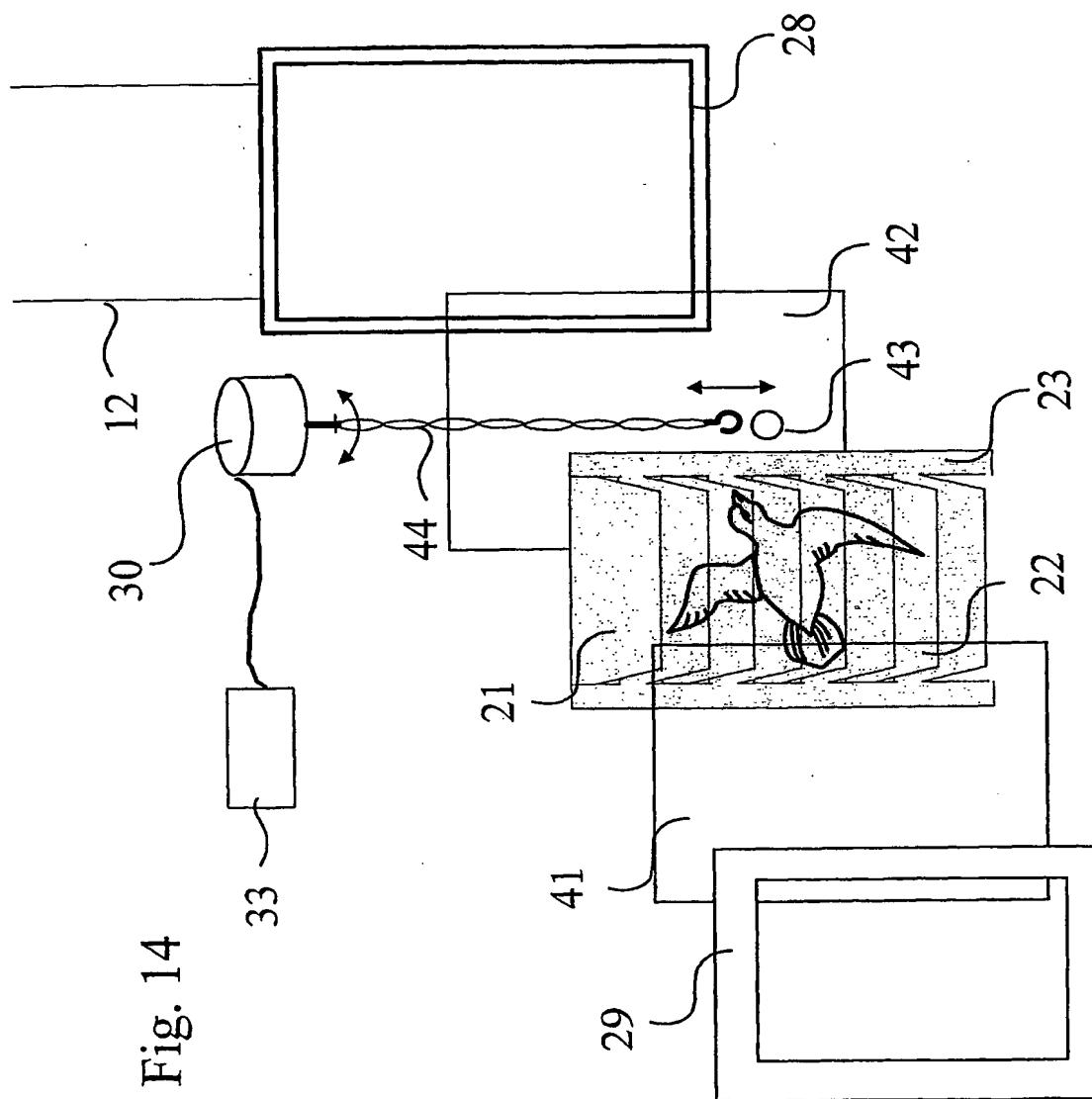
Fig. 13D

Fig. 13E

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Fig. 14



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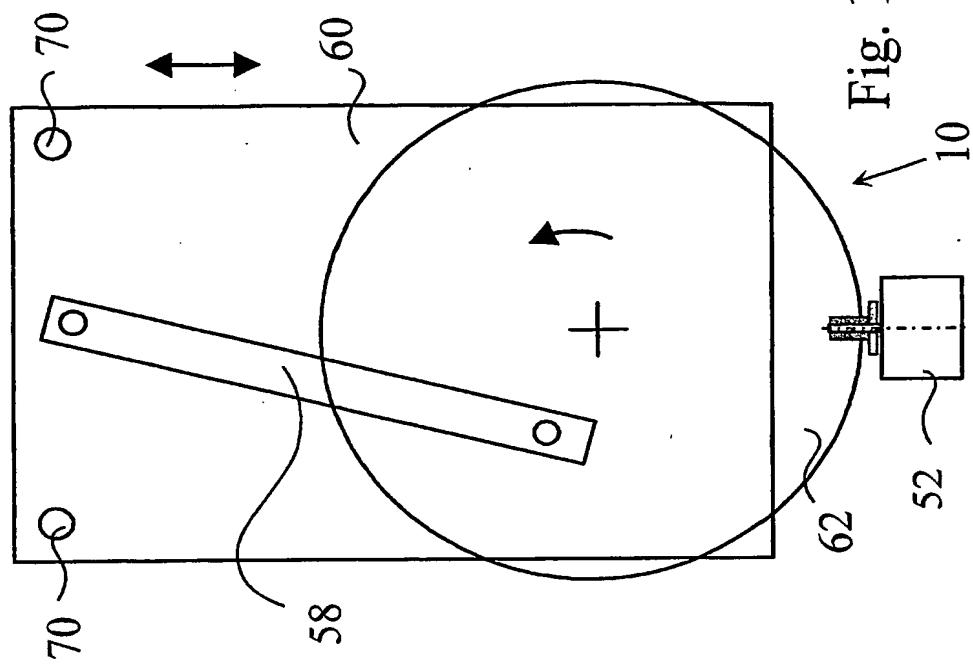


Fig. 16

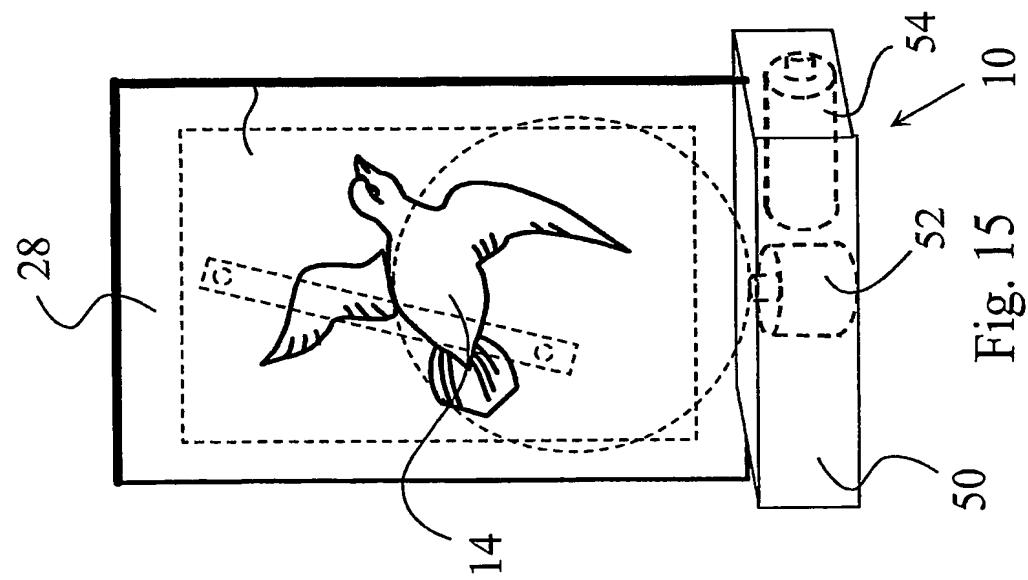


Fig. 15

Fig. 15 10

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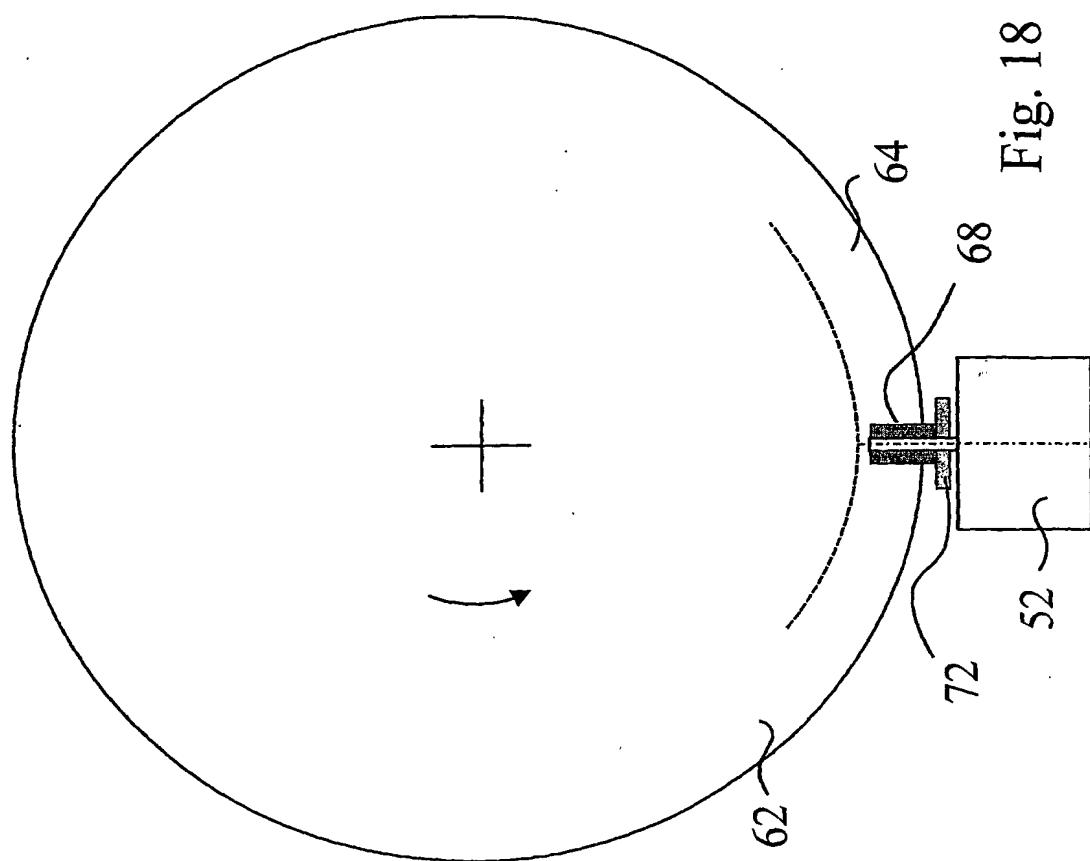


Fig. 18

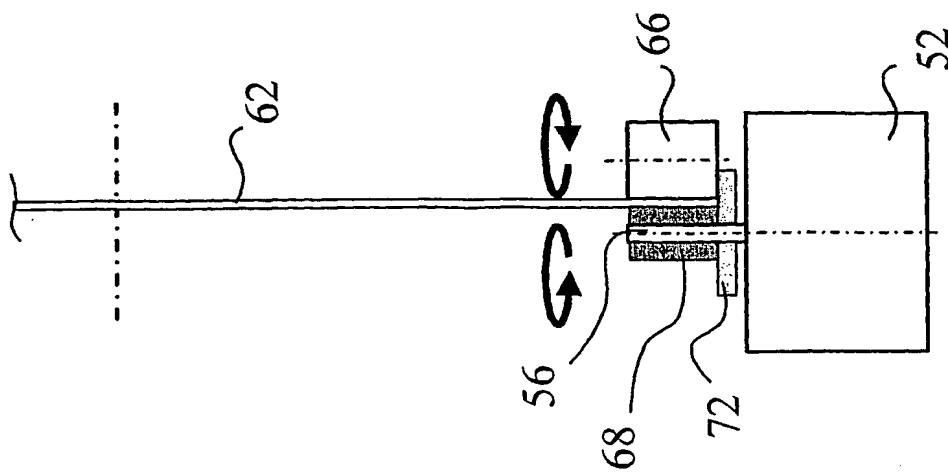
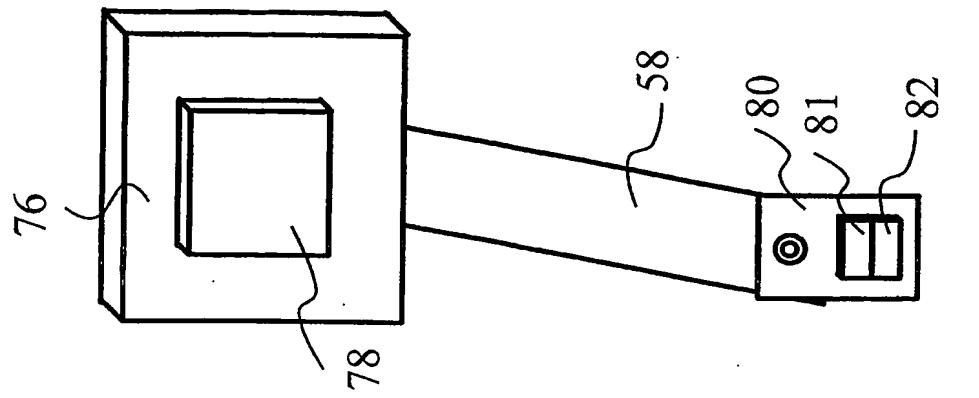
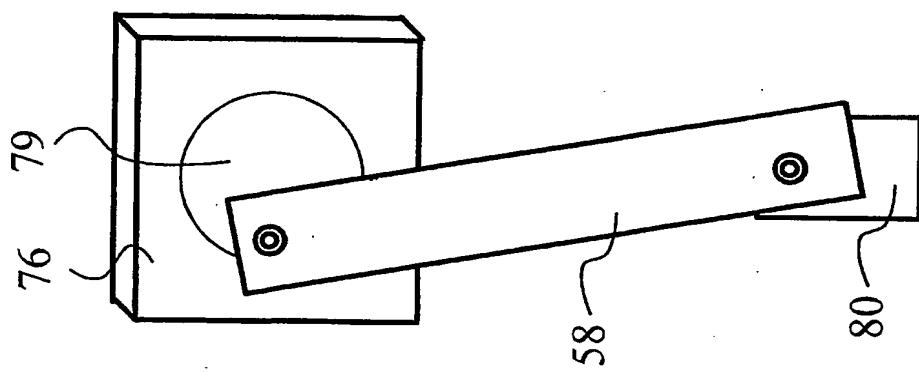
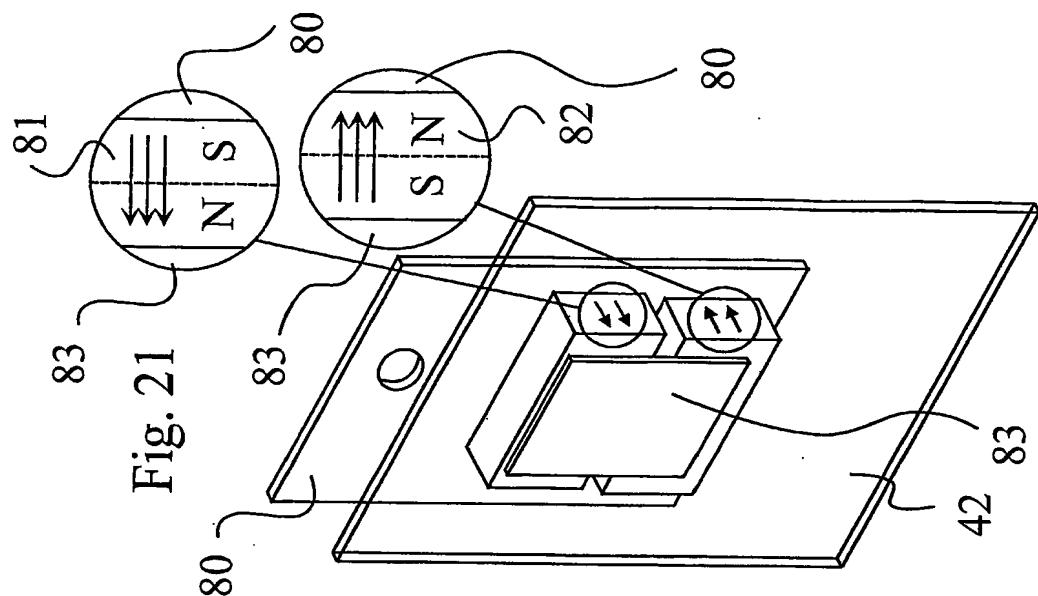


Fig. 17

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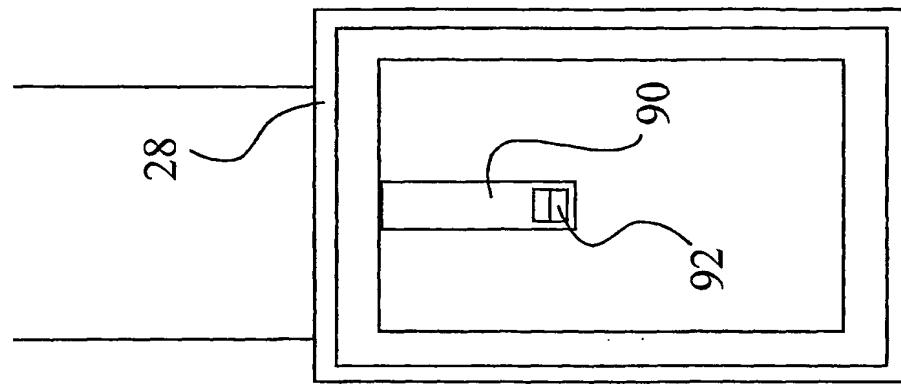
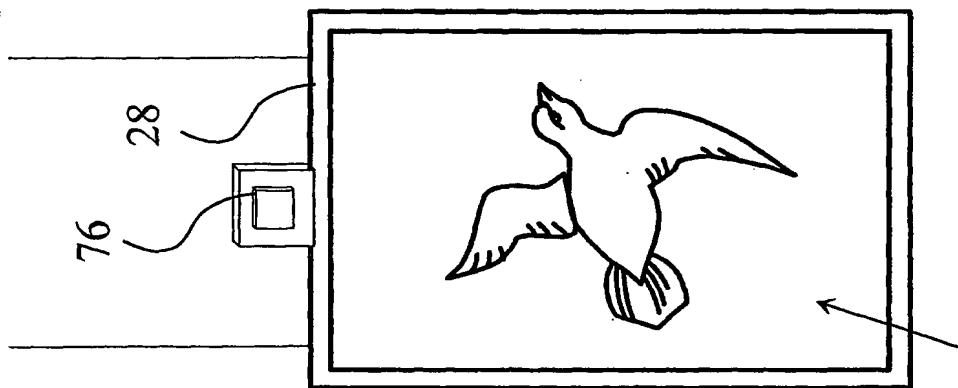


Fig. 24



10 Fig. 23

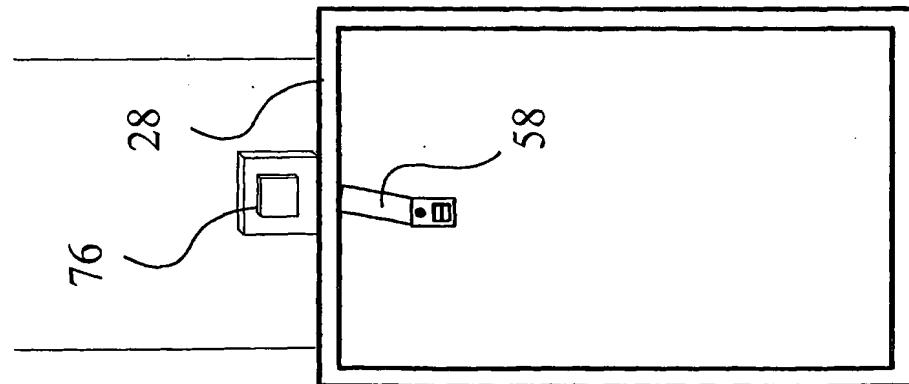


Fig. 22